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ET U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office
Attorney Docket No. 400.089US01

101724477

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Donald L. Yates
Paul A. Morgan

05/16/01

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of conveyance:

Assignment Merger
 Security Agreement Change of Name
 Other

Execution Date: April 26, 2001 and April 27, 2001

2. Name and address of receiving party(ies):

Name: Micron Technology, Inc.

Street Address: 8000 South Federal Way

City: Boise State: ID ZIP: 83716-9632

Additional name(s) & address(es) attached? Yes No



4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is April 26, 2001 and April 27, 2001.

A. Patent Application No(s). 09/858980

B. Patent No(s).

Title: **REMOVAL OF ORGANIC MATERIAL IN INTEGRATED CIRCUIT FABRICATION USING OZONATED ORGANIC ACID SOLUTIONS**

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Thomas W. Leffert
Address: Fogg Slifer & Polglaze, P.A.
P.O. Box 581009
Minneapolis, MN 55458-1009

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR §3.41): \$ 40.00

Enclosed
 Authorized to be charged to deposit account

8. Please charge any additional fees or credit any overpayments to Deposit account number: 501373

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is an original or a true copy of the original document.

Thomas W. Leffert/Reg. #40,697
Name of Person Signing

Thomas W. Leffert
Signature

MAY 16, 01
Date

Total number of pages including cover sheet, attachments, and document(s): 3

Mail documents to be recorded with required cover sheet information to:
Commissioner for Patents
Box Patent Application
Washington, D.C. 20231

PATENT
REEL: 011817 FRAME: 0485

ASSIGNMENT

WHEREAS, we, Donald L. Yates, residing at 11151 Musket Street, Boise, ID 83713, and Paul A. Morgan, residing at 12768 S. Cloverdale Road, Kuna, ID 83634 made certain new and useful inventions and improvements for which we executed an application for Letters Patent of the United States herewith, and which is entitled **REMOVAL OF ORGANIC MATERIAL IN INTEGRATED CIRCUIT FABRICATION USING OZONATED ORGANIC ACID SOLUTIONS**.

AND WHEREAS, Micron Technology, Inc., a corporation organized and existing under and by virtue of the laws of the State of Delaware, and having an office and place of business at 8000 South Federal Way, Boise, ID 83716-9632, (hereinafter "Assignee") is desirous of acquiring the entire right, title and interest in and to said inventions, improvements and application and in and to the Letters Patent to be obtained therefor;

NOW, THEREFORE, to all whom it may concern, be it known that for good and valuable consideration, the receipt and sufficiency whereof is hereby acknowledged, we have sold, assigned, and transferred, and by these presents do sell, assign and transfer unto said Assignee, its successors or assigns, the entire right, title and interest for all countries in and to all inventions and improvements disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and in and to any and all applications which have been or shall be filed in any foreign countries for Letters Patent on the said inventions and improvements, including an assignment of all rights under the provisions of the International Convention, and all Letters Patent of foreign countries which may be granted therefrom; and we do hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent for the aforesaid inventions and improvements to the said Assignee as the assignee of the entire right, title and interest in and to the same, for the use of the said Assignee, its successors and assigns.

AND, for the consideration aforesaid, we do hereby agree that we and our respective executors and legal representatives will make, execute and deliver any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said Assignee, its successors and representatives all facts known to us relating to said improvements and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable more effectually to secure to and vest in said Assignee, its successors or assigns the entire right, title and interest in and to the said improvements, inventions, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

AND, furthermore we covenant and agree with said Assignee, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by me/us and that full right to convey the same as herein expressed is possessed by us.

